

MOSFET

OptiMOS[™]5 Power-Transistor, 60 V

Features

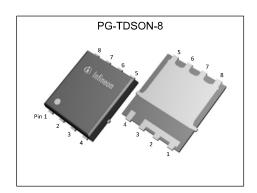
- Optimized for synchronous rectification
- 100% avalanche tested
 Superior thermal performance
 175°C rated
- N-channel
- Pb-free lead plating : RoHS compliantHalogen-free according to EC61249-2-21

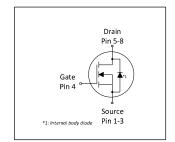
Product validation

Fully qualified according to JEDEC for Industrial Applications

Key Performance Parameters Table 1

Parameter	Value	Unit		
V _{DS}	60	V		
R _{DS(on),max}	1.15	m $Ω$		
I _D	288	А		
Qoss	103	nC		
Q _G (0V4.5V)	63	nC		











Type / Ordering Code	Package	Marking	Related Links
ISC011N06LM5	PG-TDSON-8 FL	011N06L	-

OptiMOSTM5 Power-Transistor, 60 V ISC011N06LM5



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1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatan	Comple al	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	-	288 204 37	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =50 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1152	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E _{AS}	-	-	570	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	188 3.0	W	T _C =25 °C T _A =25 °C, R _{thJA} =50 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1 55/175/56

Thermal characteristics 2

Table 3 Thermal characteristics

Parameter	Cumbal		Values		Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.		Note / Test Condition
Thermal resistance, junction - case, bottom	R_{thJC}	-	0.6	0.8	°C/W	-
Thermal resistance, junction - case, top	R_{thJC}	-	-	20	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	_	_	50	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed in as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual

See Diagram 3 for more detailed information

⁴⁾ See Diagram 13 for more detailed information

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3 Electrical characteristics at T_j =25 °C, unless otherwise specified

Table 4 **Static characteristics**

Danier dan	0		Values			N
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	60	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	$V_{\rm GS(th)}$	1.1	-	2.3	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=116\ \mu {\rm A}$
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μA	V _{DS} =60 V, V _{GS} =0 V, T _j =25 °C V _{DS} =60 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	0.85 1.1	1.15 1.45	mΩ	V _{GS} =10 V, I _D =50 A V _{GS} =4.5 V, I _D =25 A
Gate resistance ¹⁾	R _G	-	1.9	-	Ω	-
Transconductance	g_{fs}	_	230	-	S	V _{DS} ≥2 / _D R _{DS(on)max} , / _D =50 A

 Table 5
 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition	
Farameter	Symbol	Min.	Тур.	Max.	Onit	Note / Test Condition	
Input capacitance ¹⁾	Ciss	-	8500	11000	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Output capacitance ¹⁾	Coss	-	1700	2300	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Reverse transfer capacitance ¹⁾	C _{rss}	-	68	90	pF	V _{GS} =0 V, V _{DS} =30 V, f=1 MHz	
Turn-on delay time	$t_{\sf d(on)}$	_	7	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Rise time	t _r	-	10	-	ns	V_{DD} =30 V, V_{GS} =10 V, I_{D} =50 A, $R_{\text{G,ext}}$ =1.6 Ω	
Turn-off delay time	$t_{ m d(off)}$	_	78	-	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	
Fall time	t_{f}	_	32	_	ns	$V_{\rm DD}$ =30 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 Ω	

Gate charge characteristics²⁾ Table 6

Parameter	Cumbal	Values			11!4	Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q_{gs}	-	21	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	$Q_{g(th)}$	-	14	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate to drain charge	Q_{gd}	-	18	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	25	-	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	63	84	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.5	-	V	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 4.5 V
Gate charge total ¹⁾	Qg	-	127	170	nC	V_{DD} =30 V, I_{D} =50 A, V_{GS} =0 to 10 V
Gate charge total, sync. FET	Q _{g(sync)}	-	118	-	nC	V _{DS} =0.1 V, V _{GS} =0 to 10 V
Output charge	Q _{oss}	-	103	_	nC	V _{DS} =30 V, V _{GS} =0 V

Defined by design. Not subject to production test.
See "Gate charge waveforms" for parameter definition

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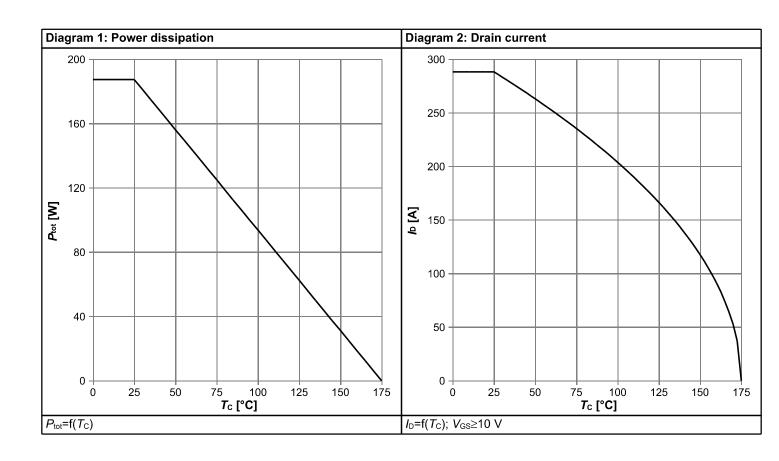


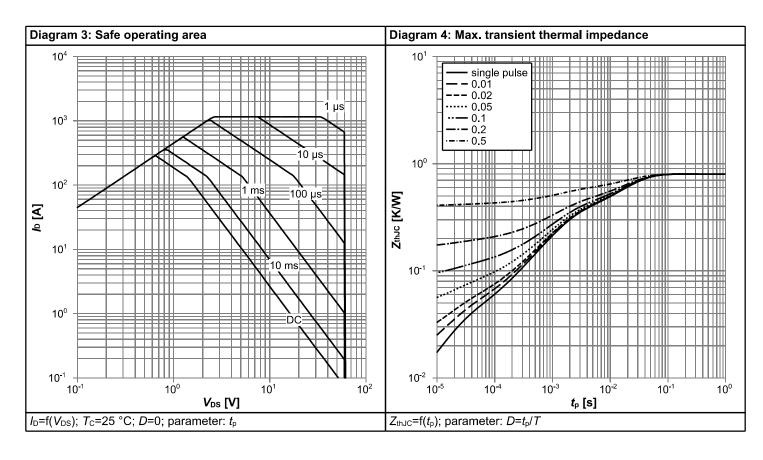
Table 7 Reverse diode

Parameter	Cymah al		Values			Note / Total Octobries
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	153	Α	<i>T</i> _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1152	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.80	1.1	V	V _{GS} =0 V, I _F =50 A, T _j =25 °C
Reverse recovery time ¹⁾	<i>t</i> _{rr}	-	56	-	ns	V _R =30 V, I _F =50 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	_	73	-	nC	V _R =30 V, I _F =50 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

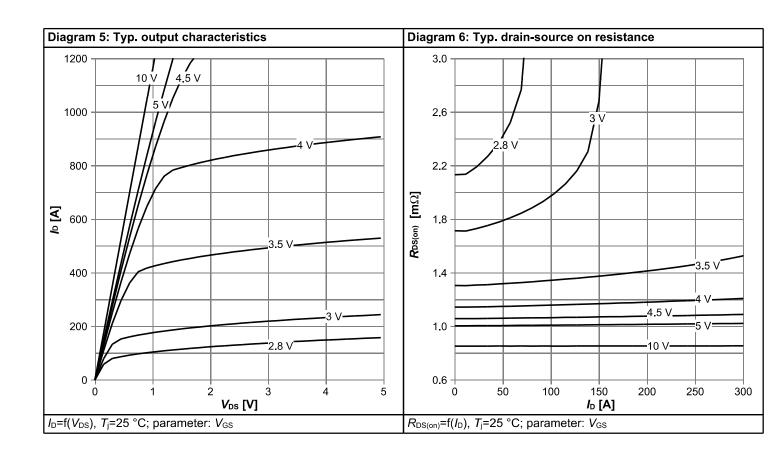


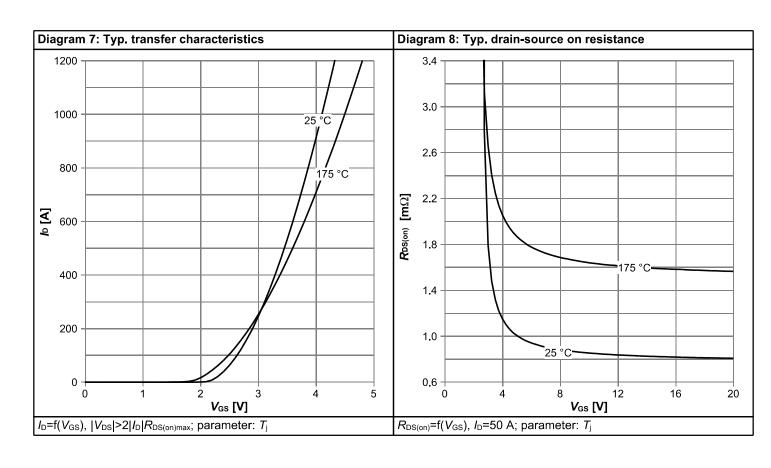
4 Electrical characteristics diagrams



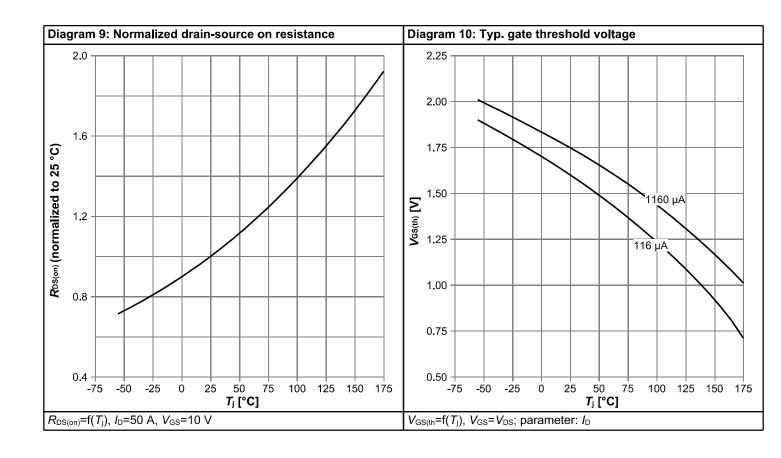


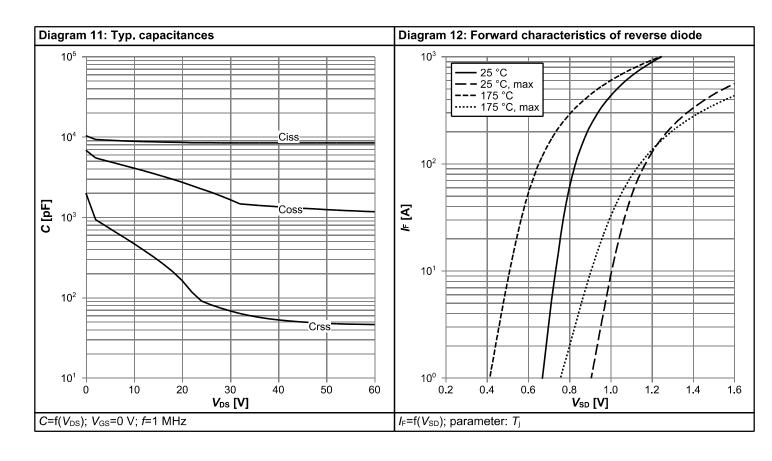




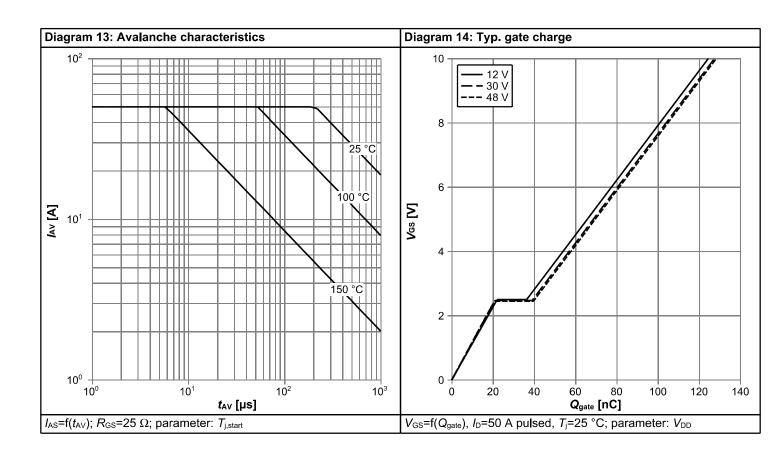


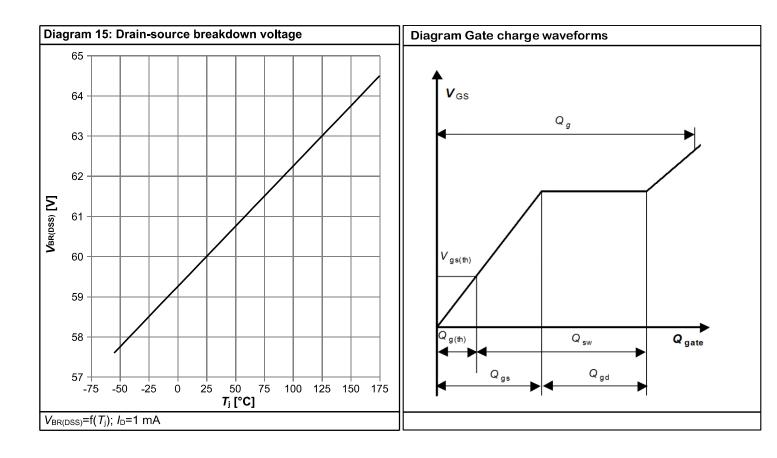














5 Package Outlines

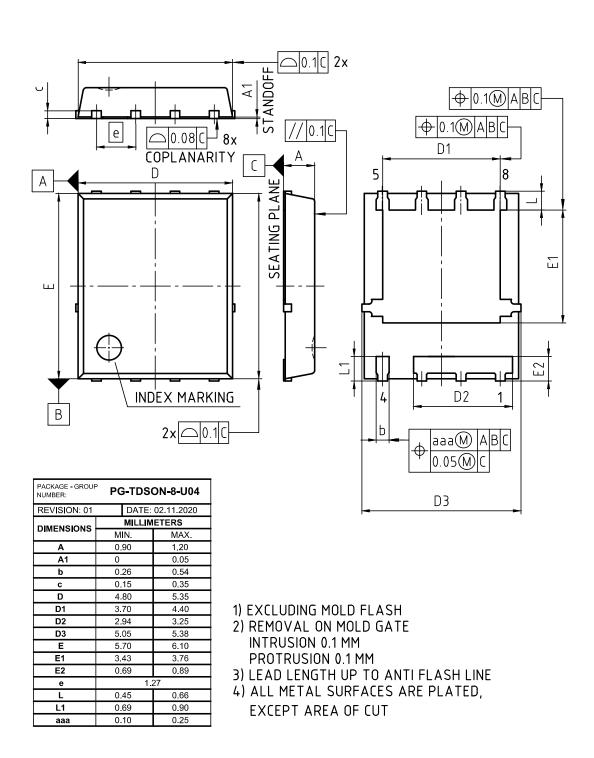


Figure 1 Outline PG-TDSON-8 FL, dimensions in mm

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Revision History

ISC011N06LM5

Revision: 2021-07-02, Rev. 2.1

Previous Revision

1 10110401	Trovidus Novision							
Revision	Revision Date Subjects (major changes since last revision)							
2.0	2021-03-12	Release of final version						
2.1	2021-07-02	Update max Rdson						

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